

DESCRIPTION

The SPE0514 are designed by TVS array that is to protect sensitive electronics from damage or latch-up due to ESD. They are designed for use in applications where board space is at a premium. SPE0514 will protect up to four lines, and may be used on lines where the signal polarities swing above and below ground.

SPE0514 offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

SPE0514 may be used to meet the immunity requirements of IEC 61000-4-2, level 4. The small SOT-563 package makes them ideal for use in portable electronics such as cell phones, PDA's, notebook computers, and digital cameras.

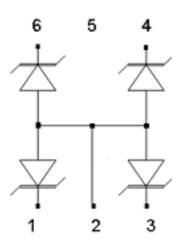
APPLICATIONS

- Cellular Handsets and Accessories
- ◆ Cordless Phone
- ◆ PDA
- Notebooks and Handhelds
- Portable Instrumentation
- ♦ Digital Cameras
- MP3 Player

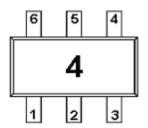
FEATURES

- ◆ Transient protection for data lines to IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns)
- Protects four I/O lines
- Working voltage: 5V
- Low leakage current
- Low operating and clamping voltages

PIN CONFIGURATION (SOT-563/SC-89)



PART MARKING



ORDERINGINFORMATION

Part Number		Package	Part Marking
	SPE0514S56RGB	SOT-563	4

※ SPE0514S56RGB: Tape Reel; Pb − Free; Halogen -Free

ABSOULTE MAXIMUM RATINGS

(Ta=25°C Unless otherwise noted)

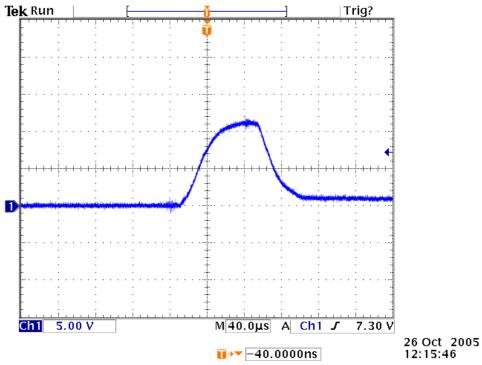
Parameter	Symbol	Typical	Unit
Peak Pulse Power (tp = 8/20 μs)	Ppk	250	W
Maximum Peak Pulse Current (tp = 8/20 μs)	Ipp	7	A
ESD per IEC 61000 – 4 – 2 (Air)	Vpp	±15	KV
ESD per IEC 61000 – 4 – 2 (Contact)	Vpp	±8	KV
Operating Junction Temperature	TJ	-55 ~ 125	$^{\circ}$
Storage Temperature Range	Tstg	-55 ~ 150	$^{\circ}$
Lead Soldering Temperature	TL	260 (10sec)	$^{\circ}\!\mathbb{C}$

ELECTRICAL CHARACTERISTICS

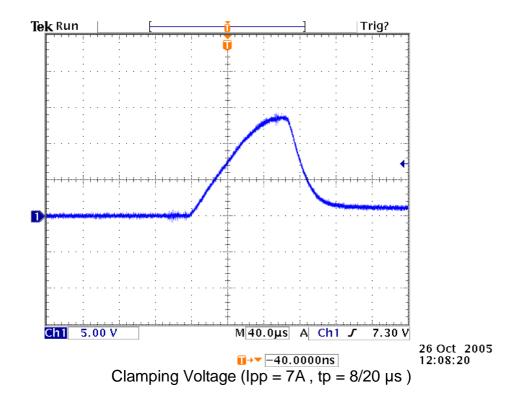
(Ta=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Reverse Stand – Off Voltage	Vrwm				5	V
Reverse Breakdown Voltage	VBR	It = 1 mA	6			V
Reverse Leakage Current	Ir	$V_{RWM} = 5V$, $T=25^{\circ}C$		0.01	1	μΑ
Reverse Leakage Current	Ir	$V_{RWM} = 3V$, $T=25^{\circ}C$		0.01	0.5	μΑ
Clamping Voltage	Vc	$Ipp = 1A$, $tp = 8/20 \mu s$			11	V
Clamping Voltage	Vc	$Ipp = 7A$, $tp = 8/20 \mu s$			15	V
Junction Capacitance	Cj	Between I/O Pin and GND $V_R = 0V$, $f = 1MHz$		10	20	pF

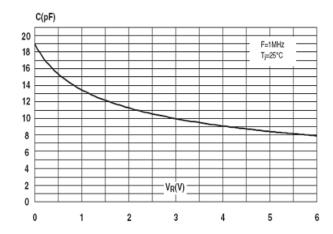
TYPICAL CHARACTERISTICS



Clamping Voltage (Ipp = 1A, tp = $8/20 \mu s$)



TYPICAL CHARACTERISTICS



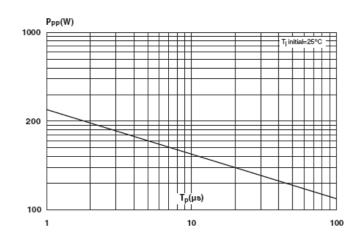
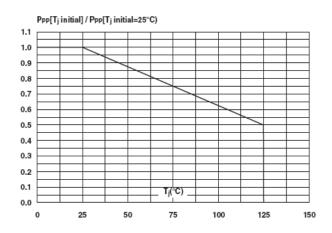


Fig 1: Junction Capacitance V.S Reverse Voltage Applied





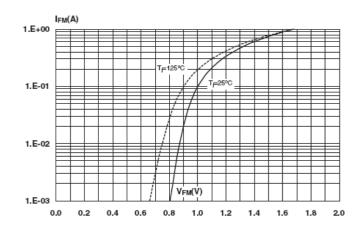


Fig 3 : Relative Variation of Peal Plus Power V.S Initial Junction Temperature

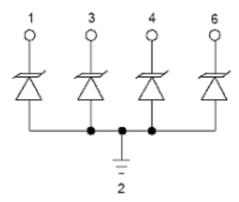
Fig 4: Forward Voltage Drop V.S Peak Forward Current

APPLICATION NOTE

Device Connection for Protection of Four Data Lines

SPE0514 is designed to protect up to four data lines. The device is connected as follows:

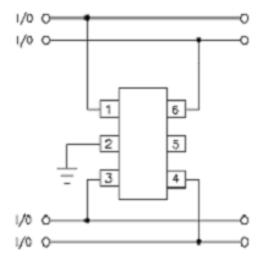
1. The TVS protection of four I/O lines is achieved by connecting pins 1, 3, 4 and 6 to the data lines. Pin 2 is connected to ground. The ground connection should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance.



Circuit Board Layout Recommendations for Suppression of ESD

Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- 1. Place the TVS near the input terminals or connectors to restrict transient coupling.
- 2. Minimize the path length between the TVS and the protected line.
- 3. Minimize all conductive loops including power and ground loops.
- 4. The ESD transient return path to ground should be kept as short as possible.
- 5. Never run critical signals near board edges
- 6. Use ground planes whenever possible.



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